

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Tsung-Yeh WU	02/06/2018
Chia-Wei HUANG	02/06/2018
Yung-Feng CHENG	02/06/2018
RECEIVING PARTY DATA	
Name:	UNITED MICROELECTRONICS CORP.
Street Address:	No3, Li-Hsin Rd.II, Hsinchu Science Park
City:	Hsinchu
State/Country:	Taiwan ROC
Postal Code:	30078
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15879788
CORRESPONDENCE DATA	
Fax Number:	(703)880-7487
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-639-0151
Email:	assignment@WPAT.COM
Correspondent Name:	WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS
Address Line 1:	8230 BOONE BLVD, SUITE 405
Address Line 4:	VIENNA, VIRGINIA 22182
ATTORNEY DOCKET NUMBER:	67407-715
NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/
DATE SIGNED:	02/06/2018
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 4	
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source=CDA#page3.tif	

Serial No. _____
Attorney Docket No. _____
Ref. No. UMCD-2017-0674
Sundial Ref. No. US13417PA

Combined Declaration and Assignment for Patent Application

For the subject matter which is claimed and for which a patent is sought on the invention entitled:

**METHOD FOR GENERATING MASKS FOR MANUFACTURING OF A SEMICONDUCTOR
STRUCTURE AND METHOD FOR MANUFACTURING A SEMICONDUCTOR STRUCTURE
USING THE SAME**

I hereby declare that: As a below named inventor

The specification of which is attached hereto unless the following box is checked

☐ was filed on

January 25, 2018

as United States Application Number or PCT International Application Number

15/879,788

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that willful false statements made in this statement is punishable under 18 U.S.C. 1001 by fine or/and imprisonment of not more than five (5) years.

ASSIGNMENT

WHEREAS, I(we), the named inventor(s), whose post office address(es) appear(s) below, hereinafter referred to as Assignor

WHEREAS, United Microelectronics Corp.

whose post office address is No3, Li-Hsin Rd.II, Hsinchu Science Park, Taiwan 30078, R.O.C.

hereinafter referred to as Assignee, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), Assignor, by these presents do sell, assign and transfer unto said Assignee, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part, and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

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including additional documents that may be required to affirm the rights of Assignee in and to said Invention, all without further consideration. Assignor also agrees, without further consideration and at Assignee's expense, to identify and communicate to Assignee at Assignee's request documents and information concerning the Invention that are within Assignor's possession or control, and to provide further assurances and testimony on behalf of Assignee that lawfully may be required of Assignor in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. Assignor's obligations under this instrument shall extend to Assignor's heirs, executors, administrators and other legal representatives;

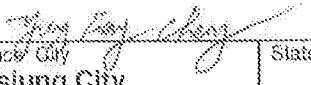
ALSO, Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to Assignee, as the Assignee of the entire right, title and interest in and to the same, for Assignee's sole use and behoof; and for the use and behoof of Assignee's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made.

Legal Name of the Sole Or First Inventor			
First And Middle Name Tsung-Yeh		Last Name of Inventor WU	
Signature <i>Tsung-Yeh Wu</i>		Signature Date (month/day/year) 06 06 2018	
Residence: City Tainan City	State	Citizenship Taiwan (R.O.C.)	
Mailing Address No.80, Aly. 68, Ln. 750, Ziqiang Rd., Yongkang Dist., Tainan City 710, Taiwan (R.O.C.)			
City Tainan City	State	Zip 710	Country Taiwan (R.O.C.)

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Legal Name of the Joint Inventor			
First And Middle Name Chia-Wei		Last Name of Inventor HUANG	
Signature <i>Chia Wei Huang</i>		Signature Date (month/day/year) FEB 05 2018	
Residence: City Kaohsiung City	State	Citizenship Taiwan (R.O.C.)	
Mailing Address No.14, Wuzhou St., Qianzhen Dist., Kaohsiung City 806, Taiwan (R.O.C.)			
City Kaohsiung City	State	Zip 806	Country Taiwan (R.O.C.)

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Legal Name of the Joint Inventor			
First And Middle Name Yung-Feng		Last Name of Inventor CHENG	
Signature 		Signature Date (month/day/year) FEB 06 2018	
Residence City Kaohsiung City	State	Citizenship Taiwan (R.O.C.)	
Mailing Address No.20-32, Dapi Rd., Niasong Dist., Kaohsiung City 833,Taiwan (R.O.C.)			
City Kaohsiung City	State	Zip 833	Country Taiwan (R.O.C.)